

SN54LS292, SN54LS294, SN74LS292, SN74LS294 PROGRAMMABLE FREQUENCY DIVIDERS/DIGITAL TIMERS

SDLS153 – D2628, JANUARY 1981 – REVISED MARCH 1988

- **Count Divider Chain**
- **Digitally Programmable from 2^2 to 2^n**
($n = 31$ for 'LS292, $n = 15$ for 'LS294)
- **Useable Frequency Range from DC to 30 MHz**
- **Easily Expandable**
- **Applications**
 - **Frequency Division**
 - **Digital Timing**

description

These programmable frequency dividers/digital timers contain 31 flip-flops plus 30 gates ('LS292) or 15 flip-flops plus 29 gates ('LS294) on a single chip. The count modulo is under digital control of the inputs provided.

Both types feature an active-low clear input to initialize the state of all flip-flops. To facilitate incoming inspection, test points are provided (TP1, TP2, and TP3 on the 'LS292 and TP on the 'LS294). These test points are not intended to drive system loads. Both types feature two clock inputs; either one may be used for clock gating. (See the function table below.)

A brief look at the digital timing capabilities of the 'LS292 will show that with a 1-MHz input frequency, programming for 2^{10} will give a period of 1.024 ms, and 2^{20} will give a period of 1.05 sec, 2^{26} will give a period of 1.12 min, and 2^{31} will give a period of 35.79 min.

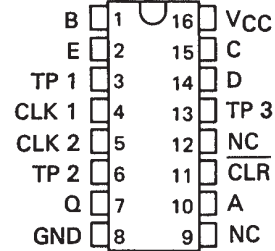
These devices are easily cascadable giving limitless possibilities to timing delays that can be achieved.

FUNCTION TABLE

CLEAR	CLK 1	CLK 2	Q OUTPUT MODE
L	X	X	Cleared to L
H	↑	L	Count
H	L	↑	Count
H	H	X	Inhibit
H	X	H	Inhibit

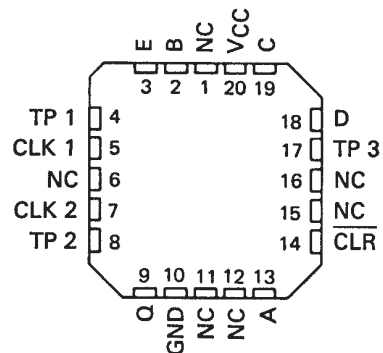
SN54LS292 . . . J OR W PACKAGE
SN74LS292 . . . N PACKAGE

(TOP VIEW)



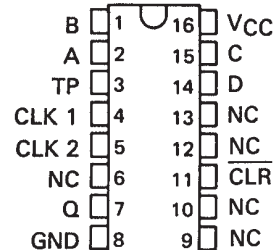
SN54LS292 . . . FK PACKAGE

(TOP VIEW)



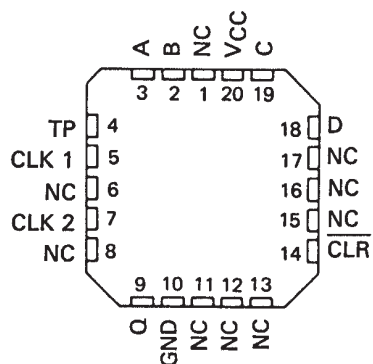
SN54LS294 . . . J OR W PACKAGE
SN74LS294 . . . N PACKAGE

(TOP VIEW)



SN54LS294 . . . FK PACKAGE

(TOP VIEW)



NC – No internal connection.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



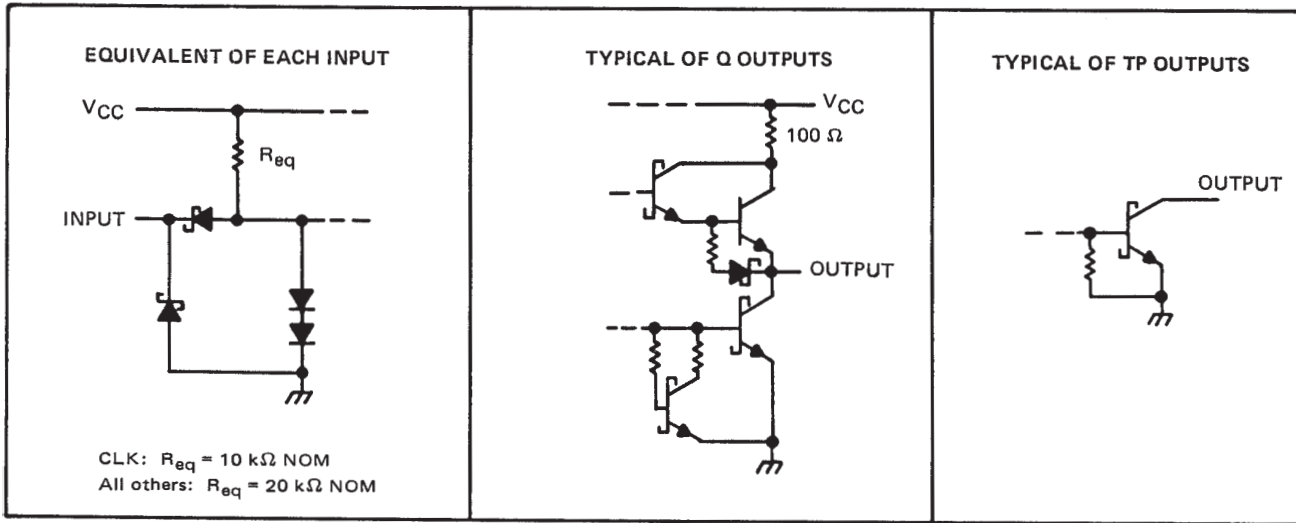
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1988, Texas Instruments Incorporated

SN54LS292, SN54LS294, SN74LS292, SN74LS294 PROGRAMMABLE FREQUENCY DIVIDERS/DIGITAL TIMERS

SDLS153 – D2628, JANUARY 1981 – REVISED MARCH 1988

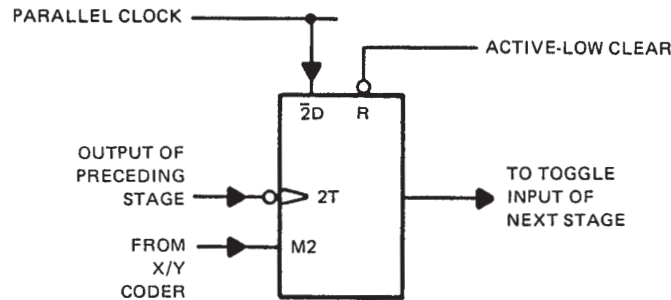
schematics of inputs and outputs



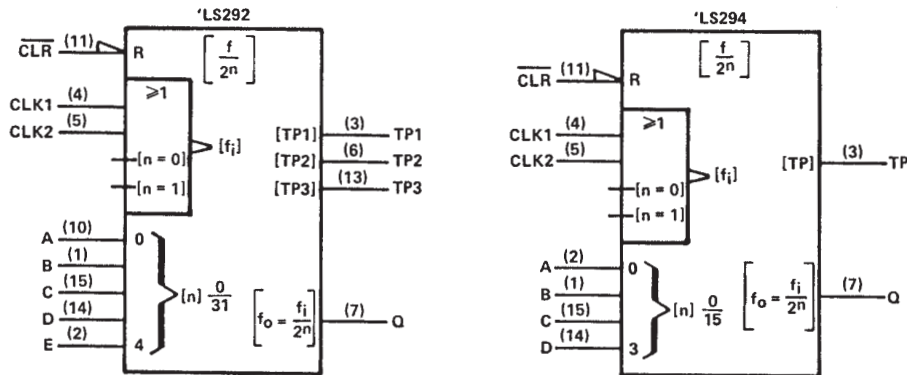
operation

The functional block diagram shows that the count modulo is controlled by an X/Y decoder connected to the mode control inputs of several flip-flops. These flip-flops with mode controls each have a "D" input connected to the parallel clock line and a "T" input driven by the preceding stage. The parallel clock frequency is always the input frequency divided by four.

The X/Y decoder output selected by the programming inputs goes low. While a mode control is low, the "D" input of that flip-flop is enabled, and the signal from the parallel clock line ($f_{in} \div 4$) is passed to the "T" input of the following stage. All the other mode controls are high enabling the "T" inputs and causing each flip-flop in turn to divide by two.



logic symbols†



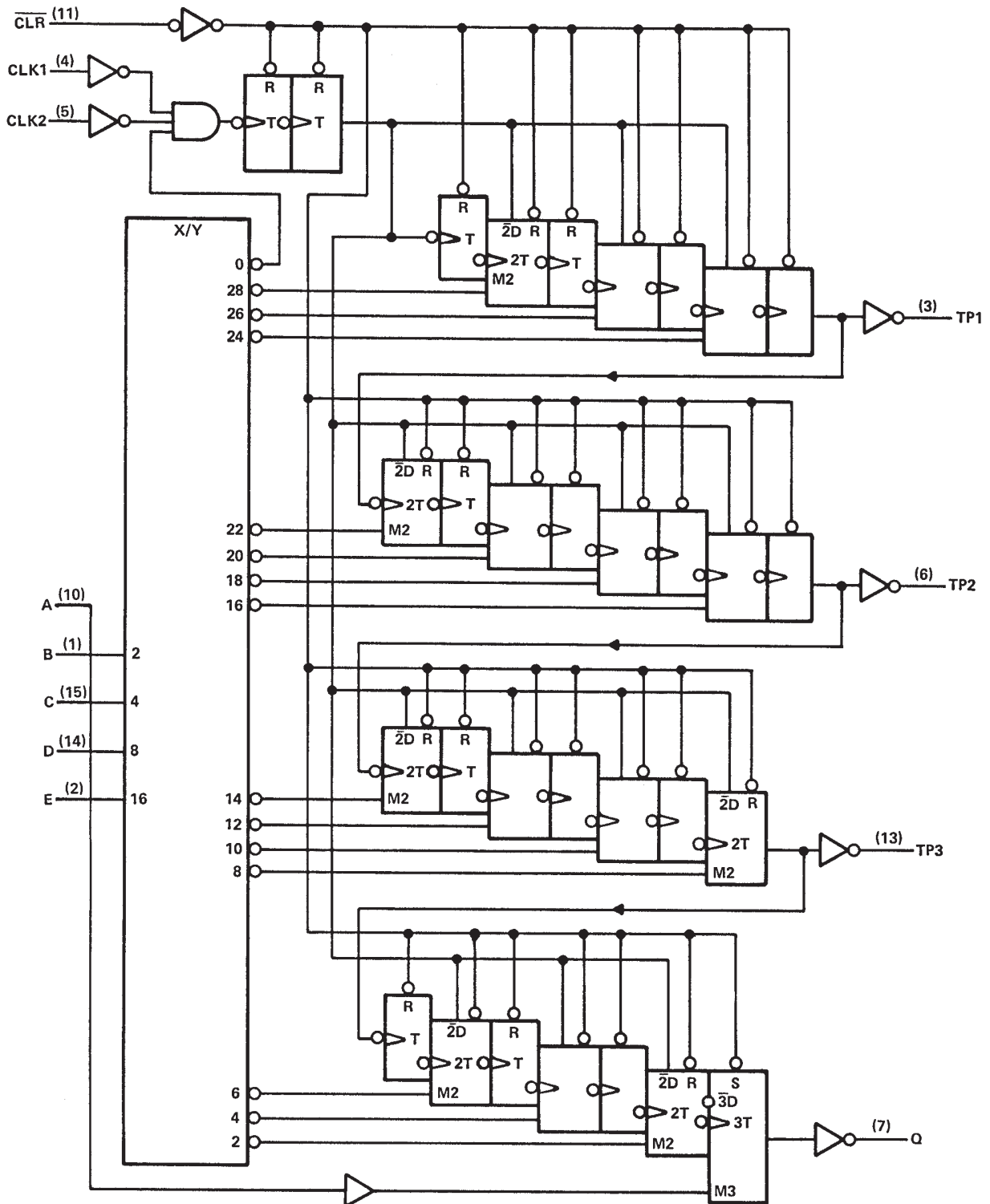
†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for J, N, and W packages.

SN54LS292, SN54LS294, SN74LS292, SN74LS294 PROGRAMMABLE FREQUENCY DIVIDERS/DIGITAL TIMERS

SDLS153 - D2628, JANUARY 1981 - REVISED MARCH 1988

logic diagram (positive logic)

'LS292



Pin numbers shown are for J, N, and W packages.

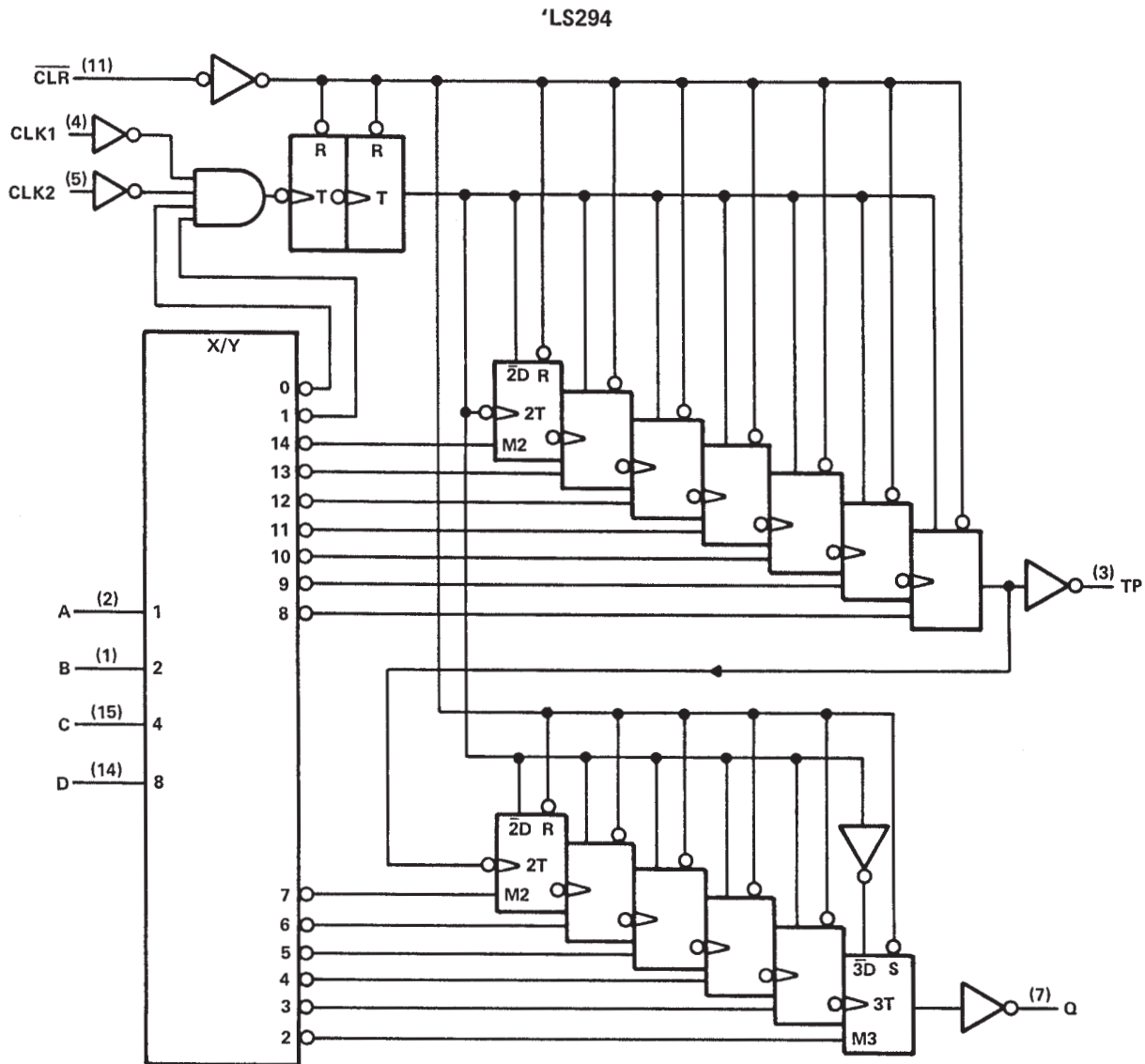


POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

SN54LS292, SN54LS294, SN74LS292, SN74LS294 PROGRAMMABLE FREQUENCY DIVIDERS/DIGITAL TIMERS

SDLS153 – D2628, JANUARY 1981 – REVISED MARCH 1988

logic diagram (positive logic)



Pin numbers shown are for J, N, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage	7 V
Operating free-air temperature range: SN54LS292, SN54LS294	-55°C to 125°C
SN74LS292, SN74LS294	0°C to 70°C
Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

SN54LS292, SN54LS294, SN74LS292, SN74LS294 PROGRAMMABLE FREQUENCY DIVIDERS/DIGITAL TIMERS

SDLS153 – D2628, JANUARY 1981 – REVISED MARCH 1988

recommended operating conditions

		SN54LS'			SN74LS'			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage				0.8			V
I _{OH}	High-level output current (Q only)				-1.2			mA
I _{OL}	Low-level output current (Q only)				24			mA
f _{clock}	Clock frequency	0	30		0	30		MHz
t _w	Duration of clock input pulse	16			16			ns
t _w	Duration of clear pulse	'LS292		55		55		ns
		'LS294		35		35		
t _{su}	Clear inactive-state setup time	15			15			ns
T _A	Operating free-air temperature	-55		125		0 70		°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		SN54LS'			SN74LS'			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V _{IK}		V _{CC} = MIN, I _I = -18 mA		-1.5			-1.5			V
V _{OH}	Q	V _{CC} = MIN, V _{IH} = 2 V, I _{OH} = -1.2 mA, V _{IL} = MAX		2.4	3.4		2.4	3.4		V
V _{OL}	Q	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX	I _{OL} = 12 mA	0.25	0.4		0.25	0.4		V
			I _{OL} = 24 mA				0.35	0.5		
			I _{OL} = 0.5 mA				0.25	0.4		
I _I		V _{CC} = MAX, V _I = 7 V		0.1			0.1			mA
I _{IH}		V _{CC} = MAX, V _I = 2.7 V		20			20			μA
I _{IL}	CLK1, CLK2	V _{CC} = MAX, V _I = 0.4 V		-0.8			-0.8			mA
	All others			-0.4			-0.4			
I _{OS} §	Q	V _{CC} = MAX		-30		-130	-30		-130	mA
I _{CC}	'LS292	V _{CC} = MAX, All inputs grounded, All outputs open		40	75		40	75		mA
	'LS294			30	50		30	50		

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

§ The duration of the short-circuit should not exceed one second.

¶ The TP output or outputs are not intended to drive external loads but are solely provided for test points.

SN54LS292, SN54LS294, SN74LS292, SN74LS294 PROGRAMMABLE FREQUENCY DIVIDERS/DIGITAL TIMERS

SDLS153 – D2628, JANUARY 1981 – REVISED MARCH 1988

switching characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$, $R_L = 667\ \Omega$, $C_L = 45\text{ pF}$ (see Figure 1)

PARAMETER†	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS292			'LS294			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
f_{max}	CLK1 or 2			30	50		30	50	MHz	
t_{PLH}		Q	Modulo set at 22, A thru E = LLLHL ('LS292) A thru D = LLHL ('LS294)	55	90		55	90	ns	
t_{PHL}		Q		80	120		80	120	ns	
t_{PHL}	CLR	Q		85	130		35	65	ns	

† f_{MAX} = maximum clock frequency

t_{PLH} = Propagation delay time, low-to-high-level output

t_{PHL} = Propagation delay time, high-to-low-level output

NOTE 2: Load circuits and voltage waveforms are shown in Section 1. To be used on TP outputs only.

'LS292 FUNCTION TABLE

PROGRAMMING INPUTS					FREQUENCY DIVISION							
					Q		TP1		TP2		TP3	
E	D	C	B	A	BINARY	DECIMAL	BINARY	DECIMAL	BINARY	DECIMAL	BINARY	DECIMAL
L	L	L	L	L	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit
L	L	L	L	H	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit	Inhibit
L	L	L	H	L	2 ²	4	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
L	L	L	H	H	2 ³	8	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
L	L	H	L	L	2 ⁴	16	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
L	L	H	L	H	2 ⁵	32	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
L	L	H	H	L	2 ⁶	64	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
L	L	H	H	H	2 ⁷	128	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
L	H	L	L	L	2 ⁸	256	2 ⁹	512	2 ¹⁷	131,072	2 ²	4
L	H	L	L	H	2 ⁹	512	2 ⁹	512	2 ¹⁷	131,072	2 ²	4
L	H	L	H	L	2 ¹⁰	1,024	2 ⁹	512	2 ¹⁷	131,072	2 ⁴	16
L	H	L	H	H	2 ¹¹	2,048	2 ⁹	512	2 ¹⁷	131,072	2 ⁴	16
L	H	H	L	L	2 ¹²	4,096	2 ⁹	512	2 ¹⁷	131,072	2 ⁶	64
L	H	H	L	H	2 ¹³	8,192	2 ⁹	512	2 ¹⁷	131,072	2 ⁶	64
L	H	H	H	L	2 ¹⁴	16,384	2 ⁹	512	Disabled Low		2 ⁸	256
L	H	H	H	H	2 ¹⁵	32,768	2 ⁹	512	Disabled Low		2 ⁸	256
H	L	L	L	L	2 ¹⁶	65,536	2 ⁹	512	2 ³	8	2 ¹⁰	1,024
H	L	L	L	H	2 ¹⁷	131,072	2 ⁹	512	2 ³	8	2 ¹⁰	1,024
H	L	L	H	L	2 ¹⁸	262,144	2 ⁹	512	2 ⁵	32	2 ¹²	4,096
H	L	L	H	H	2 ¹⁹	524,288	2 ⁹	512	2 ⁵	32	2 ¹²	4,096
H	L	H	L	L	2 ²⁰	1,048,576	2 ⁹	512	2 ⁷	128	2 ¹⁴	16,384
H	L	H	L	H	2 ²¹	2,097,152	2 ⁹	512	2 ⁷	128	2 ¹⁴	16,384
H	L	H	H	L	2 ²²	4,194,304	Disabled Low		2 ⁹	512	2 ¹⁶	65,536
H	L	H	H	H	2 ²³	8,388,608	Disabled Low		2 ⁹	512	2 ¹⁶	65,536
H	H	L	L	L	2 ²⁴	16,777,216	2 ³	8	2 ¹¹	2,048	2 ¹⁸	262,144
H	H	L	L	H	2 ²⁵	33,554,432	2 ³	8	2 ¹¹	2,048	2 ¹⁸	262,144
H	H	L	H	L	2 ²⁶	67,108,864	2 ⁵	32	2 ¹³	8,192	2 ²⁰	1,048,576
H	H	L	H	H	2 ²⁷	134,217,728	2 ⁵	32	2 ¹³	8,192	2 ²⁰	1,048,576
H	H	H	L	L	2 ²⁸	268,435,456	2 ⁷	128	2 ¹⁵	32,768	2 ²²	4,194,304
H	H	H	L	H	2 ²⁹	536,870,912	2 ⁷	128	2 ¹⁵	32,768	2 ²²	4,194,304
H	H	H	H	L	2 ³⁰	1,073,741,824	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216
H	H	H	H	H	2 ³¹	2,147,483,648	2 ⁹	512	2 ¹⁷	131,072	2 ²⁴	16,777,216



SN54LS292, SN54LS294, SN74LS292, SN74LS294 PROGRAMMABLE FREQUENCY DIVIDERS/DIGITAL TIMERS

SDLS153 – D2628, JANUARY 1981 – REVISED MARCH 1988

'LS294 FUNCTION TABLE

PROGRAMMING INPUTS				FREQUENCY DIVISION			
				Q		TP	
D	C	B	A	BINARY	DECIMAL	BINARY	DECIMAL
L	L	L	L	Inhibit	Inhibit	Inhibit	Inhibit
L	L	L	H	Inhibit	Inhibit	Inhibit	Inhibit
L	L	H	L	2 ²	4	2 ⁹	512
L	L	H	H	2 ³	8	2 ⁹	512
L	H	L	L	2 ⁴	16	2 ⁹	512
L	H	L	H	2 ⁵	32	2 ⁹	512
L	H	H	L	2 ⁶	64	2 ⁹	512
L	H	H	H	2 ⁷	128	Disabled Low	
H	L	L	L	2 ⁸	256	2 ²	4
H	L	L	H	2 ⁹	512	2 ³	8
H	L	H	L	2 ¹⁰	1,024	2 ⁴	16
H	L	H	H	2 ¹¹	2,048	2 ⁵	32
H	H	L	L	2 ¹²	4,096	2 ⁶	64
H	H	L	H	2 ¹³	8,192	2 ⁷	128
H	H	H	L	2 ¹⁴	16,384	2 ⁸	256
H	H	H	H	2 ¹⁵	32,768	2 ⁹	512

switching loads

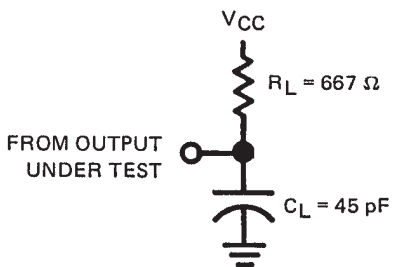
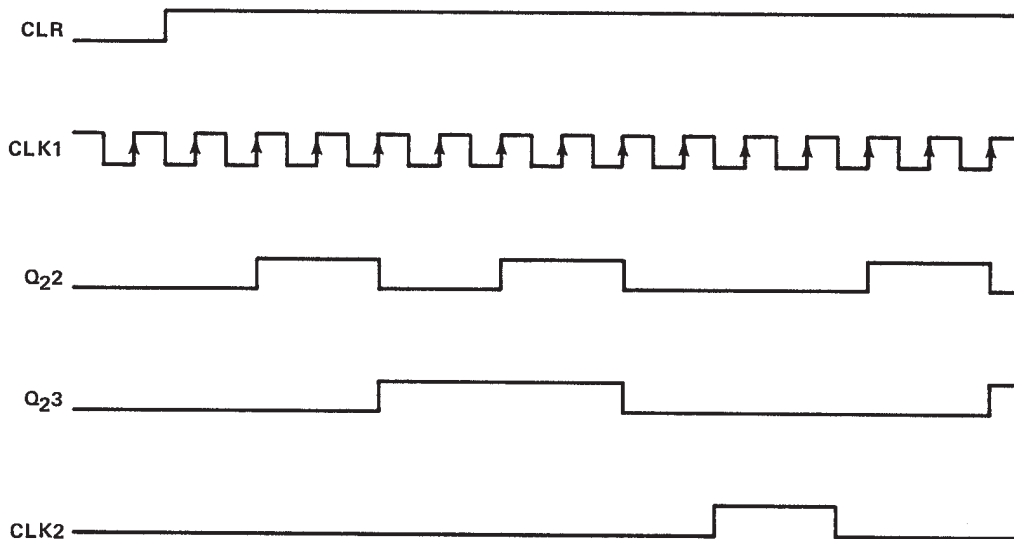


FIGURE 1

'LS292 and 'LS294 timing diagram



PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS292N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS292N	Samples
SN74LS292N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70		
SN74LS292N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70		
SN74LS294N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS294N	Samples
SN74LS294N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS294N	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - $\triangle C$ Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - $\triangle D$ The 20 pin end lead shoulder width is a vendor option, either half or full width.

4040049/E 12/2002

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products

Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
OMAP Applications Processors	www.ti.com/omap
Wireless Connectivity	www.ti.com/wirelessconnectivity

Applications

Automotive and Transportation	www.ti.com/automotive
Communications and Telecom	www.ti.com/communications
Computers and Peripherals	www.ti.com/computers
Consumer Electronics	www.ti.com/consumer-apps
Energy and Lighting	www.ti.com/energy
Industrial	www.ti.com/industrial
Medical	www.ti.com/medical
Security	www.ti.com/security
Space, Avionics and Defense	www.ti.com/space-avionics-defense
Video and Imaging	www.ti.com/video

TI E2E Community

e2e.ti.com